

RH7G04BBJFRA

Pch -40V -40A Power MOSFET

V _{DSS}	-40V
R _{DS(on)} (Max.)	11.9mΩ
I _D	±40A
P _D	75W

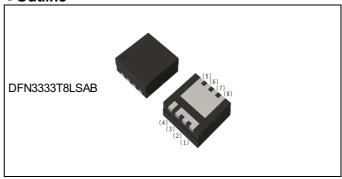
Features

- 1) Wettable Flanks Product
- 2) AEC-Q101 Qualified
- 3) 100% Avalanche tested

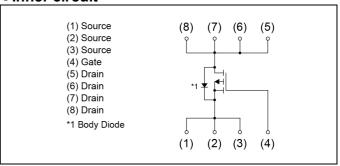
Application

ADAS/Info./Lighting/Body

Outline



●Inner circuit



Packaging specifications

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	Packing	Embossed Tape				
	Reel size (mm)	330				
Type	Tape width (mm)	12				
	Quantity (pcs)	3000				
	Taping code	TCB				
	Marking	G04BBJ				

● **Absolute maximum ratings** (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit	
Drain - Source voltage		V_{DSS}	-40	V
Continuous drain current	V _{GS} = -10V	I _D *1	±40	Α
Pulsed drain current	I _{DP} *2	±80	Α	
Gate - Source voltage		V_{GSS}	+5/-20	V
Avalanche current, single pulse	I _{AS} *3	-27	Α	
Avalanche energy, single pulse	E _{AS} *3	54	mJ	
Power dissipation	P _D *1	75	W	
Junction temperature	T _j	175	°C	
Operating junction and storage temper	rature range	T _{stg}	-55 to +175	°C

●Thermal resistance

Parameter	Symbol	Values			Lloit
		Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R _{thJC} *1	-	-	2.0	°C/W

● Electrical characteristics (T_a = 25°C)

Doromotor	Symbol	Conditions	Values			Unit
Parameter	Parameter Symbol Conditions		Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V _{(BR)DSS}	$V_{GS} = 0V$, $I_D = -1mA$	-40	-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	$\frac{\Delta V_{(BR)DSS}}{\Delta T_i} I_D = -1 \text{mA}$ referenced to 25°C		-28	-	mV/°C
Zero gate voltage drain current	I _{DSS}	V _{DS} = -32V, V _{GS} = 0V	-	-	-1	μA
Gate - Source leakage current	I _{GSS}	$V_{GS} = +5/-20V, V_{DS} = 0V$	1	1	±500	nA
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -1.7 \text{mA}$	-1.0	-	-2.5	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_j}$	I _D = -1.7mA referenced to 25°C	-	3.1	-	mV/°C
Static drain - source	D *4	V _{GS} = -10V, I _D = -20A	-	9.1	11.9	mO.
on - state resistance	R _{DS(on)} *4	V _{GS} = -4.5V, I _D = -10A	-	11.7	15.2	mΩ
Gate resistance	R _G	f = 1MHz, open drain	-	15	-	Ω
Forward Transfer Admittance	Y _{fs} *4	V _{DS} = -5V, I _D = -10A	14	-	-	S

^{*1} $T_c = 25 ^{\circ}\text{C}$, Limited only by maximum junction temperature $T_j = 175 ^{\circ}\text{C}$.

^{*2} Pw ≤10µs , Duty cycle ≤1%

^{*3} L=0.1mH, V_{DD} =-20V, R_G =25 Ω , Starting T_i =25 $^{\circ}$ C, See Fig.3-1,3-2

^{*4} Pulsed

● Electrical characteristics (T_a = 25°C)

Darameter	Symbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C _{iss}	V _{GS} = 0V	-	2670	-	
Output capacitance	C _{oss}	V _{DS} = -20V	-	325	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	230	-	
Turn - on delay time	t _{d(on)} *4	V _{DD} ≃ -20V,V _{GS} = -10V	-	14	-	
Rise time	t _r *4	I _D = -10A	-	24	-	
Turn - off delay time	t _{d(off)} *4	$R_L \simeq 2\Omega$	-	175	-	ns
Fall time	t _f *4	$R_G = 1\Omega$	-	97	-	

• Gate charge characteristics $(T_a = 25^{\circ}C)$

Darameter	Cymahal	Conditions		Values			l limit
Parameter	Symbol			Min.	Тур.	Max.	Unit
Total gate above	O *4		V _{GS} = -10V	-	50	-	
Total gate charge	Q _g *4	V _{DD} ≃ -20V		-	25	-	5 C
Gate - Source charge	Q _{gs} *4	I _D = -10A	V _{GS} = -4.5V	-	6.7	-	nC
Gate - Drain charge	Q _{gd} *4			-	6.4	-	

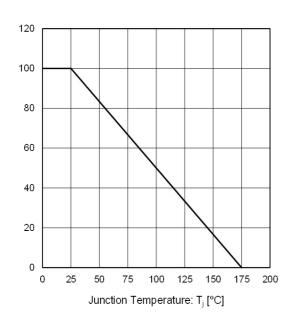
● Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
raiametei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Continuous forward current	I _S *1	T = 25°C	1	-	-40	Α
Pulse forward current	l _{SP} *2	T _a = 25°C	1	-	-80	Α
Forward voltage	V _{SD} *4	$V_{GS} = 0V, I_S = -20A$	-	-	-1.2	V
Reverse recovery time	t _{rr} *4	I _S = -10A, V _{GS} =0V	-	31	-	ns
Reverse recovery charge	Q _{rr} *4	di/dt = -100A/µs	-	34	-	nC

Power Dissipation: P_D/P_{Dmax}. [%]

• Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve



Drain Current : -I_D [A]

Fig.2 Maximum Safe Operating Area

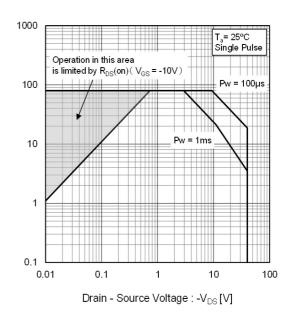


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

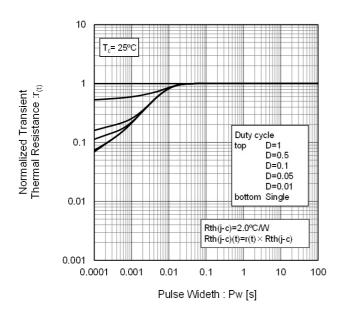
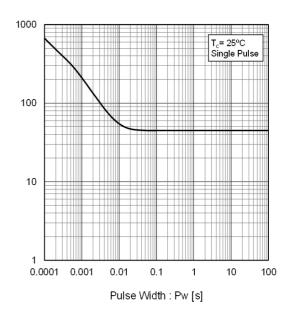
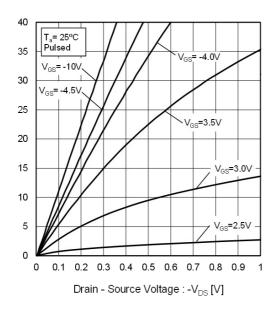


Fig.4 Single Pulse Maximum Power dissipation



Peak Transient Power: P[W]

Fig.5 Typical Output Characteristics(I)



Drain Current : -I_D [A]

Fig.6 Typical Output Characteristics(II)

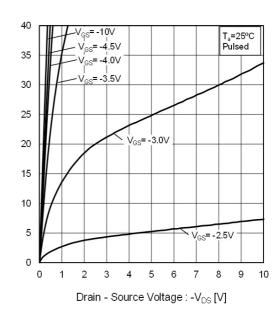
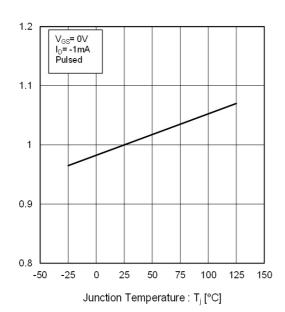


Fig.7 Breakdown Voltage vs.
Junction Temperature



Drain Current : -I_D [A]

Drain Current: -I_D[A]

• Electrical characteristic curves

Fig.8 Typical Transfer Characteristics

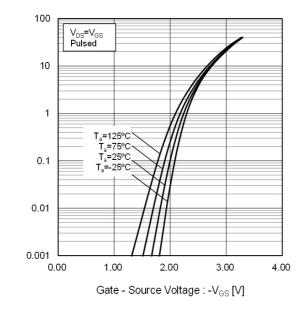


Fig.9 Gate Threshold Voltage vs.
Junction Temperature

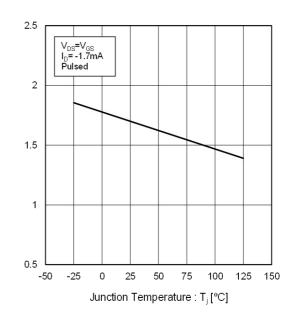
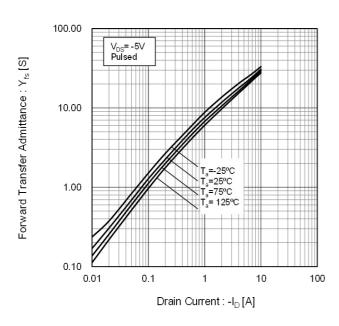


Fig.10 Forward Transfer Admittance vs.
Drain Current



Gate Threshold Voltage : - $V_{GS(th)}[V]$

Fig.11 Drain Current Derating Curve

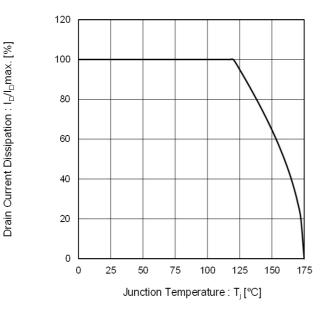
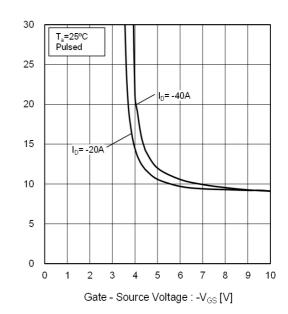


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage



Static Drain - Source On-State Resistance : $R_{\text{DS}(on)}\left[\text{m}\Omega\right]$

Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

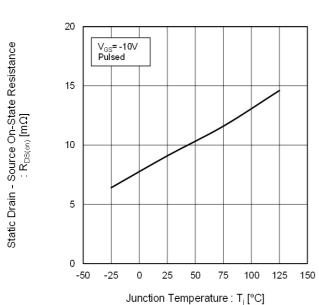


Fig.14 Static Drain - Source On - State Resistance vs. Drain Current (I)

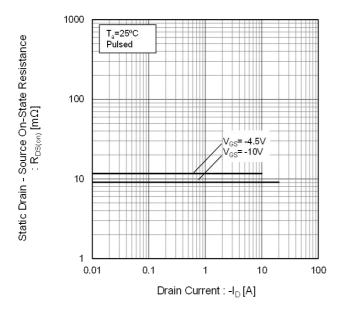
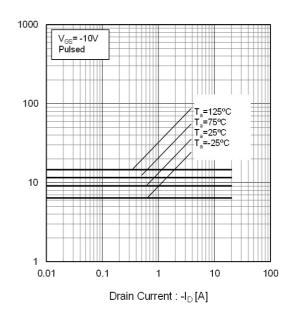


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)



Static Drain - Source On-State Resistance : $R_{DS(\omega)}\left[m\Omega\right]$

Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)

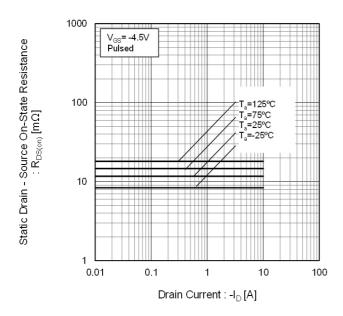


Fig.17 Typical Capacitance vs.

Drain - Source Voltage

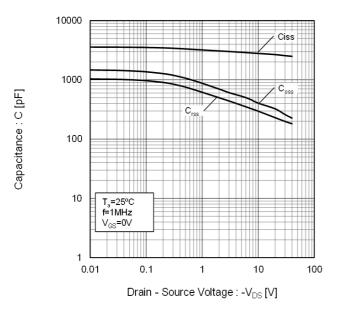
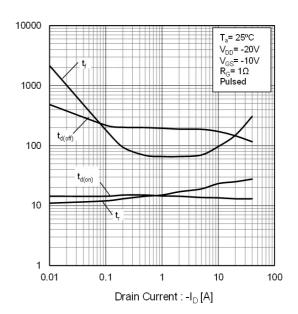


Fig.18 Switching Characteristics



Switching Time : t [ns]

Fig.19 Dynamic Input Characteristics

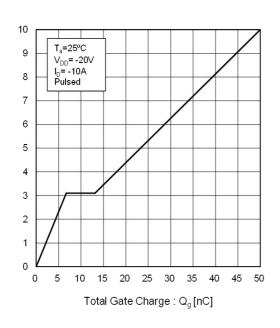
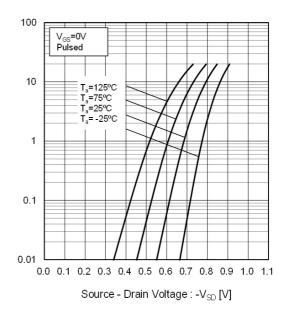


Fig.20 Source Current vs.

Source Drain Voltage



Gate - Source Voltage : -V_{GS} [V]

Source Current : -I_s [A]

Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

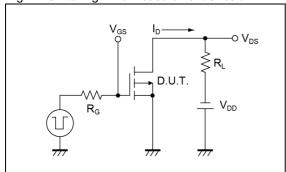


Fig.2-1 Gate Charge Measurement Circuit

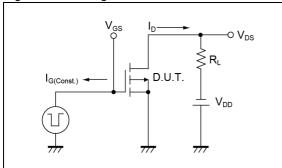


Fig.3-1 Avalanche Measurement Circuit

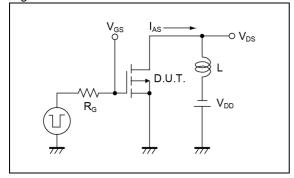


Fig.1-2 Switching Waveforms

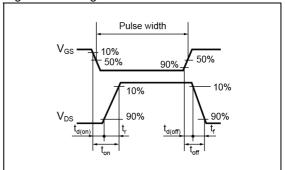


Fig.2-2 Gate Charge Waveform

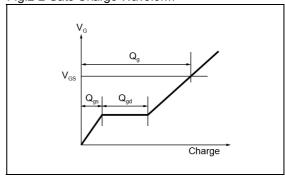
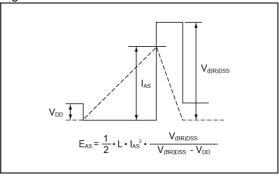
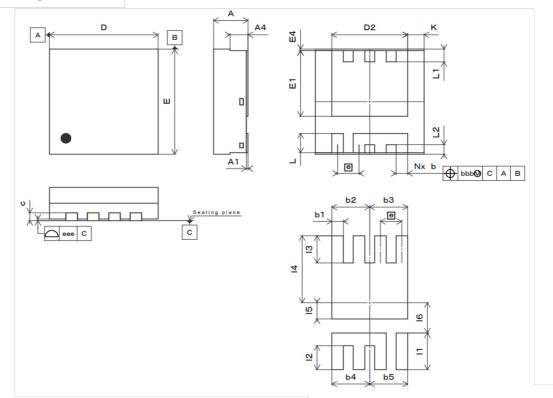


Fig.3-2 Avalanche Waveform



Dimensions

DFN3333T8LSAB



[reference pattern of soldering pads]

DIM	MILIME	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	0.900	1.100	0.035	0.043	
A1	0.000	0.050	0.000	0.002	
A4	0.300	-	0.012	-	
b	0.250	0.450	0.010	0.018	
С	0.100	0.300	0.004	0.012	
D	3.200	3.400	0.126	0.134	
D2	2.200	2.400	0.087	0.094	
E	3.200	3.400	0.126	0.134	
E1	1.960	2.160	0.077	0.085	
E4	0.005	-	0.000	. To	
е	0.6	550	0.0)26	
K	0.400	0.600	0.016	0.024	
L	0.500	0.700	0.020	0.028	
L1	0.300	0.500	0.012	0.020	
L2	0.200	0.400	0.008	0.016	
N	8				

DIM	MILIMETERS		INCHES		
וועו	MIN	MAX	MIN	MAX	
b1	0.3	350	0.0)14	
b2	1.1	50	0.0)45	
b3	1.1	50	0.0)45	
b4	1.1	50	0.045		
b5	1.1	1.150)45	
I1	1.1	50	0.0)45	
12	0.7	'50	0.0)30	
13	13 0.850 0.033)33		
14	2.100		14 2.100 0.083)83
15	0.510		0.0)20	
16	0.9	950	0.0)37	

Dimension in mm/inches



Notice

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ſ	JÁPAN	USA	EU	CHINA
Ī	CLASSⅢ	CL ACCIII	CLASS II b	СГУССШ
ſ	CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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